# VS-HFA30TA60CHN3

Vishay Semiconductors

ROHS COMPLIANT

HALOGEN

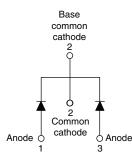
FREE

### HEXFRED<sup>®</sup> Ultrafast Soft Recovery Diode, 2 x 15 A



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PRODUCT SUMMARY					
Package	TO-220AB				
I <sub>F(AV)</sub>	2 x 15 A				
V <sub>R</sub>	600 V				
V <sub>F</sub> at I <sub>F</sub>	1.2 V				
t <sub>rr</sub> typ.	19 ns				
T <sub>J</sub> max.	150 °C				
Diode variation	Common cathode				

#### FEATURES

- Ultrafast and ultrasoft recovery
- Very low  $I_{\text{RRM}}$  and  $Q_{\text{rr}}$
- AEC-Q101 qualified, meets JESD 201 class 1A
   whisker test
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

#### DESCRIPTION

VS-HFA30TA60CHN3 is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 15 A per leg continuous current, the VS-HFA30TA60CHN3 is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I<sub>BBM</sub>) and does not exhibit any tendency to "snap-off" during the t<sub>b</sub> portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA30TA60CHN3 is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Cathode to anode voltage	V <sub>R</sub>		600	V		
Maximum continuous forward current	I	T <sub>C</sub> = 100 °C	15			
per device	I <sub>F</sub>	$1_{\rm C} = 100$ C	30	А		
Single pulse forward current	I <sub>FSM</sub>		150	A		
Maximum repetitive forward current	I <sub>FRM</sub>		60			
Maximum power dissinction	P <sub>D</sub>	T <sub>C</sub> = 25 °C	74	w		
Maximum power dissipation		T <sub>C</sub> = 100 °C	29	- vv		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +150	°C		

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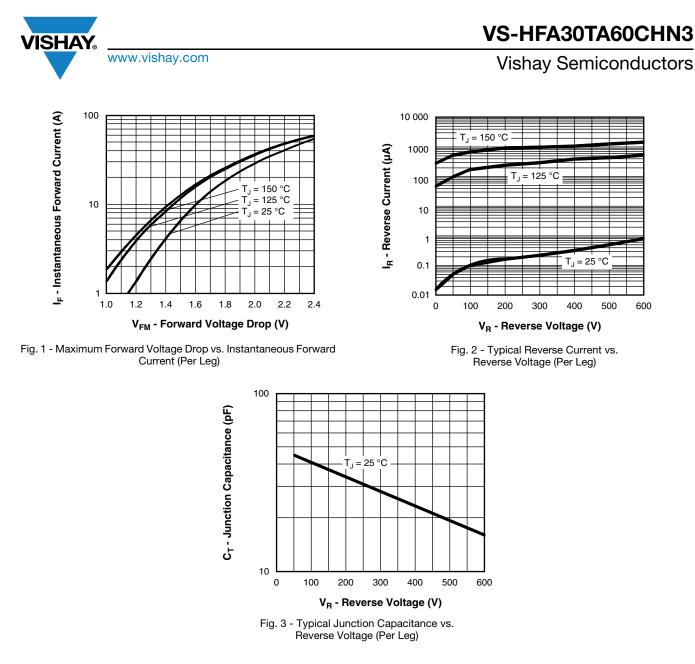
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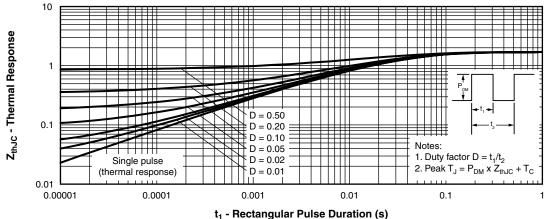
<b>ELECTRICAL SPECIFICATIONS PER LEG</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 100 μA		600	-	-	
		I <sub>F</sub> = 15 A		-	1.3	1.7	v
Maximum forward voltage	V <sub>FM</sub>	I <sub>F</sub> = 30 A	See fig. 1	-	1.5	2.0	
		I <sub>F</sub> = 15 A, T <sub>J</sub> = 125 °C		-	1.2	1.6	
Maximum reverse		$V_{R} = V_{R} \text{ rated}$ $T_{J} = 125 \text{ °C}, V_{R} = 0.8 \text{ x } V_{R} \text{ rated}$ See fig. 2		-	1.0	10	
leakage current	I <sub>RM</sub>			-	400	1000	μA
Junction capacitance	CT	V <sub>R</sub> = 200 V	See fig. 3	-	25	50	pF
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from p	ackage body	-	8	-	nH

<b>DYNAMIC RECOVERY CHARACTERISTICS PER LEG</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS MIN. TYP. MA					
	t <sub>rr</sub>	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200$	A/μs, V <sub>R</sub> = 30 V	-	19	-		
Reverse recovery time See fig. 5 and 10	t <sub>rr1</sub>	T <sub>J</sub> = 25 °C		-	42	60	ns	
	t <sub>rr2</sub>	T <sub>J</sub> = 125 °C	l <sub>F</sub> = 15 A	-	70	120		
Peak recovery current	I <sub>RRM1</sub>	T <sub>J</sub> = 25 °C		-	4.0	6.0	Α	
See fig. 6	I <sub>RRM2</sub>	T <sub>J</sub> = 125 °C		-	6.5	10	A	
Reverse recovery charge	Q <sub>rr1</sub>	T <sub>J</sub> = 25 °C	dl <sub>F</sub> /dt = 200 A/μs V <sub>B</sub> = 200 V	-	80	180	nC	
See fig. 7	Q <sub>rr2</sub>	T <sub>J</sub> = 125 °C	v <sub>R</sub> = 200 v	-	220	600	ne	
Peak rate of fall of	dl <sub>(rec)M</sub> /dt1	T <sub>J</sub> = 25 °C		-	250	-	A∕µs	
recovery current during t <sub>b</sub> See fig. 8	dl <sub>(rec)M</sub> /dt2	T <sub>J</sub> = 125 °C		-	160	-	γγµs	

THERMAL - MECHANICAL SPECIFICATIONS PER LEG							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Lead temperature	T <sub>lead</sub>	0.063" from case (1.6 mm) for 10 s	-	-	300	°C	
Junction to case, single leg conducting	D				1.7		
Junction to case, both legs conducting	– R <sub>thJC</sub>		-	-	0.85	κ/w	
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	40	r.∕ vv	
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.25	-		
Weight			-	6.0	-	g	
weight			-	0.21	-	oz.	
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)	
Marking device		Case style TO-220AB	HFA30TA60CH				









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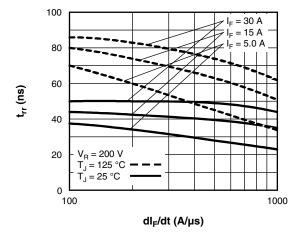


Fig. 5 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt (Per Leg)

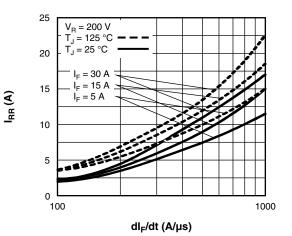


Fig. 6 - Typical Recovery Current vs. dl<sub>F</sub>/dt (Per Leg)

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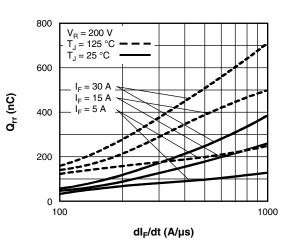


Fig. 7 - Typical Stored Charge vs. dl<sub>F</sub>/dt (Per Leg)

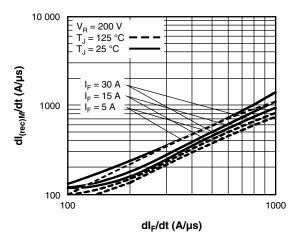


Fig. 8 - Typical dI<sub>(rec)M</sub>/dt vs. dI<sub>F</sub>/dt (Per Leg)

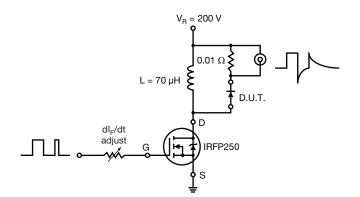


Fig. 9 - Reverse Recovery Parameter Test Circuit

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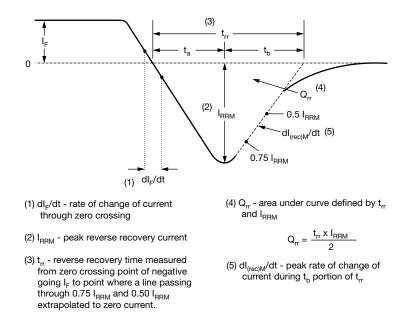
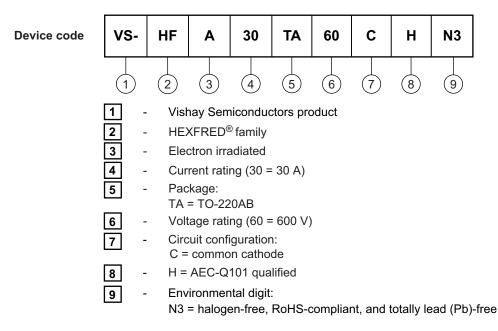


Fig. 10 - Reverse Recovery Waveform and Definitions

#### **ORDERING INFORMATION TABLE**

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ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-HFA30TA60CHN3	25	500	Antistatic plastic tube					

LINKS TO RELATED DOCUMENTS					
Dimensions		www.vishay.com/doc?95222			
Part marking information	TO-220AB-N3	www.vishay.com/doc?95028			

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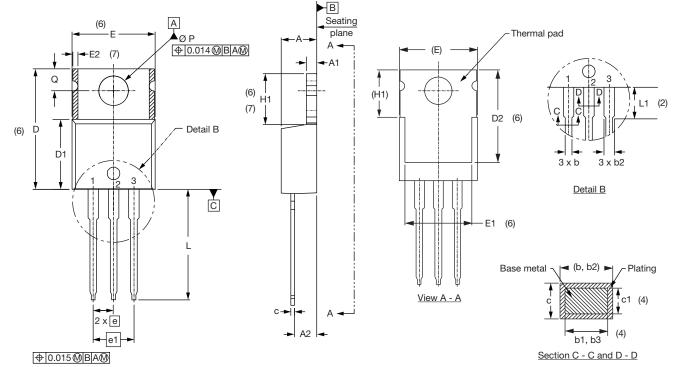
### **Outline Dimensions**



**Vishay Semiconductors** 

**TO-220AB** 

#### **DIMENSIONS** in millimeters and inches



Lead tip

SYMBOL	MILLIN	IETERS	INCHES		NOTES	
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
А	4.25	4.65	0.167	0.183		
A1	1.14	1.40	0.045	0.055		
A2	2.56	2.92	0.101	0.115		
b	0.69	1.01	0.027	0.040		
b1	0.38	0.97	0.015	0.038	4	
b2	1.20	1.73	0.047	0.068		
b3	1.14	1.73	0.045	0.068	4	
С	0.36	0.61	0.014	0.024		
c1	0.36	0.56	0.014	0.022	4	
D	14.85	15.25	0.585	0.600	3	
D1	8.38	9.02	0.330	0.355		
D2	11.68	12.88	0.460	0.507	6	

Conforms	to JEDEC <sup>®</sup>	outline	TO-220AB
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SYMBOL	MILLIN	IETERS	INCHES		NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
E	10.11	10.51	0.398	0.414	3, 6
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
е	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	5.84	6.86	0.230	0.270	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
ØP	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° t	o 93°	90° t	o 93°	

Notes

- <sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- $^{\left( 4\right) }$  Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- <sup>(8)</sup> Outline conforms to JEDEC<sup>®</sup> TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline

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